Effect of Infrared Radiation on the Hydrogen in Thin Films Double Barriers Based Melt Silicone-Germany

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Abstract

Possibilities of plasma chemical deposition of α-Si₁₋ₓGeₓ:H (x=0÷1) films undoped and doped with PH₃ or B₂H₆ have been analyzed from the viewpoint of their application in p-i-n structures of solar cell. The optical properties are considered, and the amount of hydrogen contained in those films is determined. The film properties are found to strongly depend on the film composition and the hydrogenation level. The number of hydrogen atoms in the films is varied by changing the gas mixture composition, and IR absorption in α-Si:H and α-Ge:H films is measured. The α-Si:H and α-Si₁₋ₓGeₓ:H films were used to fabricate three-layer solar with an element area of 1.3 sm² and an efficiency (η) of 9.5 %.

Keywords: Effect infrared on thin films; Amorphous silicon; Solar cells; Efficiency; Optical properties; Oscillator; Absorption coefficient; Effusion of hydrogen; Deposition rate

Introduction

Introduction of Si films and its alloy characterized by various structural phases. The most interesting of them are crystals that are in the amorphous matrix. Such alloys are produced by different methods at different technological regimes. For films of amorphous hydrogenated silicon and a-Si: H, formed by the method of cyclic sedimentation annealed in hydrogen plasma effect Staeblera-Vronsky is expressed weakly [1]. Authors [2] note the absence of the effect of Staeblera-Vronsky in Nanostructure films of a-Si:H film Silicon alloys crystallization of a-Si: H is carried out by various methods: long annealing in vacuum at 600 °C, fast heat treatment [3], laser annealing [4] and ion implantation [5]. The mobility of the charge carriers, alloying and efficiency optical absorption coefficient in films of a-Si: H vy she than crystalline silicon. Films a-Si₁₋ₓGeₓ:H are an effective and inexpensive material for making solar cells and other electronic devices [6, 7].

In this regard, the receipt of the aforementioned films and changing their conductivity type are actual tasks. [8] shows that with the change in the temperature of the substrate grow Nano crystals increases. Found that with increasing concentration of average grain size decreases RN3 (d) and the proportion of crystalline particle volume (Vc). When alloying with increasing concentration of boron, B₂H₆ value (d) does not change, and Vc is reduced. The value of photo films and efficiency-Si₁₋ₓGeₓ:H, somewhat lower than in a-Si: H [9, 10]. With the changing conditions of technology and technological parameters of hydrogen deposited on various structural phases: microcrystalline, polycrystalline, Nano crystalline, etc. of energy conversion efficiency based on Schottky barrier in films of a-Si: H was 5.5 %. Attempts have been made to obtain high efficiency solar cell (CPA ASE) (~ 9.0%) on the basis of a-Si₁₋ₓGeₓ:H [11]. Most literature data show that when using amorphous silicon and Silicon-Germanium alloys in solar cells with multilayered or cascading structure have the greatest EFFICIENCY ~ 8.5% [12]. Based on the above stated the purpose of this work is to determine the amount of hydrogen in amorphous films method for optical solid solution a-Si₁₋ₓGeₓ:H (x = 0-1) and manufacturing of solar cells based on them.

The Experimental Part

Thin films of a-Si₁₋ₓGeₓ:H (x = 0-1) received plasma chemical deposition method using gas mixtures of H₂ + SiH₄, U + GeH₄ in various proportions. Details on obtaining films shown in [11, 12].
Plasma RF field created through mainly inductive coupling. Film thickness was 0.1 ÷ 1.0 μm. Measured absorption coefficient (α), refraction (n), reflection (R), (T), width of band gap (E0) for each sample, using appropriate models [13,14]. Optical absorption at room temperature were studied by the method of [13-16] on spectrometer x-29.

**Result and Discussion**

The hydrogen concentration in a-Si$_{1-x}$Ge$_x$: H, (x = 0 ÷ 1) films is determined using the method of Brodsky et al. [14 - 17]:

$$ N = \frac{AN_x}{(1/j)} \int \frac{\alpha(\omega)}{\omega} d\omega $$

where N is the number of Avogadro and (j) the integral strength of the hydride with units cm$^2$/mole (g/j) = 3.5. If the width of the absorption indicate through and center frequency $\omega_*$, $\omega_0$ when $\Delta \omega/\omega_0 \leq 0.1$ after approximation with a tolerance of ± 2%, equation (1) can be written as follows:

$$ N = \frac{AN_x}{(1/j)\omega_0} \int \frac{\alpha(\omega)}{\omega} d\omega $$

where is: $A = \frac{(1+2\varepsilon)^2}{2\varepsilon} \varepsilon^2$ ; $\varepsilon$ - dielectric constant. For Si, $\varepsilon=12$; Ge, $\varepsilon=16$.

If the equation (2) preintegral expression Relabel AS

$$ J_x = \int \alpha(\omega) d\omega $$

- the cumulative uptake of fashion streching for each film, then in determining hydrogen concentration (NH) get a general expression in abbreviated form:

$$ N_{NH} = A_xJ_x $$

Coeficient $A_x$- for films a-Si:H, is in the field of fashion stretching 1,4-1020 cm$^{-2}$. Absorption coefficient (α) for these phones (2100 cm$^{-1}$) is 8-10.1 ÷ 1022 cm$^{-1}$. When this NH 7-1021 ÷2,1-1022 cm$^{-1}$. For films a-Ge:H AS = 1,7-1020 cm$^{-2}$. In films a-Si:H and a-Ge:H absorption frequencies 2000 и 1980 cm$^{-1}$ is caused by fluctuations in the type of valance and absorption frequencies 630 и 570 cm$^{-1}$ oscillations of type bend (fig. 1a and 1 c).

Thus, for a-Si$_{1-x}$Ge$_x$: H the place has a significant overlap, which is observed in the spectrum of IR absorption for both bands stretching Ge:H (1980 cm$^{-1}$) and Si: H (2000 cm$^{-1}$), and for bending strips around the frequency 600 cm$^{-1}$ (fig. 16) [5, 12]. It is clear that the equation (3), so did the links stretch fashion oscillating characterizes in films a-Si:H, a-Ge:H и a-Si$_{1-x}$Ge$_x$: H. Assess the relative binding hydrogen to hydrogenated amorphous a-Si$_{1-x}$Ge$_x$: H:

$$ P = \frac{N_{NH}}{N_{NH}} \frac{x}{1-x} $$

**Figure 1:** Infrared absorption Spectra of amorphous films of a-Si:H (a), a-Si$_{0.60}$Ge$_{0.40}$:H (b) and a-Ge: H (in).
Where is $N_{Si-H}$ and $N_{Ge-H}$ - hydrogen concentration in a-Si:H and a-Ge:H (in $cm^{-2}$). Equation (3) You can rewrite to fashion swings (wagging mode) films a-Si:H and a-Ge:H. Thus the value of the $N_{Si-H}$ and $N_{Ge-H}$ are determined from equations (3) to fashion rocking in the following form:

$$N_H = A_w J_w \ (5),$$

where is, $J_w = \int \frac{\alpha(\omega)}{\omega} \, d\omega$ - the cumulative uptake of fashion swinging for films a-Si:H and a-Ge:H. For specified films $A_w=1.6 \times 10^{19}$ $cm^{-2}$ and $A_w=1.1 \times 10^{19}$ $cm^{-2}$, accordingly. Knowing $N_{Ge-H}$ (where, for films a-Ge:H, $A_w=1.6 \times 10^{19}$ $cm^{-2}$ and $\alpha=5 \times 10^{1}$ $cm^{-1}$), calculate hydrogen concentration $N_H$ in the film a-Si$_x$Ge$_{1-x}$:H in the words of:

$$N_H = N_{Ge-H}^{wag} \left\{ \int \frac{\alpha(\omega)}{\omega} \, d\omega \right\} \ (6),$$

where is, $N_{Ge-H}^{wag}$ - number of links, some of the effects of net swing a-Ge:H, the value which, calculated according to the equation (5). The second factor in the expression for NH (cumulative ratio of IR absorption maxima) is a vibrational fashion stretching in the sample and in pure a-Ge:H. For the computation of the cumulative ratio used maximum satisfying the oscillatory fashion stretching $Ge:H (2000 cm^{-1})$ in the film a-Si$_x$Ge$_{1-x}$:H.

Table 1 shows the characteristic parameters of amorphous films a-Si$_x$Ge$_{1-x}$:H.

<table>
<thead>
<tr>
<th>No. film</th>
<th>$P_{ex}$ mTorr</th>
<th>$E_g$ eV</th>
<th>$P$</th>
<th>H at %</th>
<th>$N_{Si-H} cm^{-2}$</th>
<th>$N_{Ge-H} cm^{-2}$</th>
<th>NH cm$^{-2}$</th>
<th>$I_w(Ge)$</th>
<th>$I_w(Si)$</th>
<th>$I_w(Ge)/I_w(Si)$</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>0.6</td>
<td>1.32</td>
<td>1.85</td>
<td>1.3</td>
<td>6.2 $\times 10^{21}$</td>
<td>2.2 $\times 10^{21}$</td>
<td>3.1 $\times 10^{23}$</td>
<td>7.2 $\times 10^{1}$</td>
<td>6.3 $\times 10^{1}$</td>
<td>6.0 $\times 10^{2}$</td>
</tr>
<tr>
<td>2</td>
<td>1.2</td>
<td>1.36</td>
<td>2.29</td>
<td>5.1</td>
<td>9.4 $\times 10^{21}$</td>
<td>2.7 $\times 10^{21}$</td>
<td>4.0 $\times 10^{1}$</td>
<td>8.6 $\times 10^{1}$</td>
<td>7.5 $\times 10^{1}$</td>
<td>5.2 $\times 10^{2}$</td>
</tr>
<tr>
<td>3</td>
<td>1.8</td>
<td>1.41</td>
<td>2.59</td>
<td>8.7</td>
<td>1.3 $\times 10^{22}$</td>
<td>3.3 $\times 10^{21}$</td>
<td>5.1 $\times 10^{21}$</td>
<td>9.4 $\times 10^{1}$</td>
<td>8.3 $\times 10^{1}$</td>
<td>4.0 $\times 10^{2}$</td>
</tr>
<tr>
<td>4</td>
<td>2.4</td>
<td>1.44</td>
<td>3.38</td>
<td>14.7</td>
<td>2.1 $\times 10^{22}$</td>
<td>4.1 $\times 10^{21}$</td>
<td>6.2 $\times 10^{21}$</td>
<td>1.0 $\times 10^{2}$</td>
<td>9.0 $\times 10^{1}$</td>
<td>3.0 $\times 10^{2}$</td>
</tr>
<tr>
<td>5</td>
<td>3.0</td>
<td>1.52</td>
<td>4.16</td>
<td>23.7</td>
<td>2.9 $\times 10^{22}$</td>
<td>4.6 $\times 10^{21}$</td>
<td>9.7 $\times 10^{1}$</td>
<td>1.1 $\times 10^{2}$</td>
<td>1.0 $\times 10^{2}$</td>
<td>2.7 $\times 10^{2}$</td>
</tr>
</tbody>
</table>

From these data it is possible to evaluate the effect of the oscillator in film a-Si$_x$Ge$_{1-x}$:H the ratio of: $Q = J_s/J_w$,

where is, $J_s \approx J_s^{Ge} + J_s^{Si}$, $J_w \approx J_w^{Ge} + J_w^{Si}$, values $J_s^{Ge}$, $J_s^{Si}$, $J_w^{Ge}$, $J_w^{Si}$ - are integrated acquisitions fashion, stretching and rocking, accordingly. The oscillator strength $Q=0.51$ (for $x=0$) and $\Gamma=0.13$ (for $x=1$). The maximum value $P=4.16$ for $x=0.40$.

Table 1 shows the characteristic parameters of amorphous films a-Si$_x$Ge$_{1-x}$:H. On Figure 2 shows the distribution of hydrogen on film thickness $d$: certain 1- method of recoil protons, 2- method of IR absorption spectrum. You can see, the distribution of hydrogen sufficiently uniform. Unlike other methods, the method of recoil protons (MOP) sample bombarding beam of protons. When researching a-Si:H and its alloys, this allows you to get distribution hydrogen on thickness ~ 40 + 100 Å. Method of calibration accuracy is limited only by the MCS, which is determined by the largest concentration of hydrogen (NH), and IR spectroscopy of found values that match 2 + 3 %. This method provides information about the General content of both associated and not associated with Si hydrogen. A, with regard to the precise definition of hydrogen content in the volume of films, this band was analyzed INFRARED absorption 630 cm$^{-1}$. To clarify the amount of hydrogen is embedded in amorphous matrix below as follows is determined by the structural parameter (R):
Hydrogen concentration (NH), some effusion method, correlated with the concentration of hydrogen, calculated using the integrated force IW, fashion rocking 600 cm⁻¹ (pic. 3). The number of hydrogen atoms is found by at. % (CH), effusion method is defined for the data tapes and compared to the number of hydrogen atoms NA (Avogadro’s number).

\[
R = \frac{J_{2000}}{J_{2000} + J_{2100}},
\]

where is \( J_{2000} \) and \( J_{2100} \) - intensity of absorption bands at 2000 и 2100 cm⁻¹. Using the equation (3), of this ratio is determined by the concentration of hydrogen. Increase R occurs simultaneously with a decrease in the concentration of hydrogen. The highest magnitude R (before 0.8) observed for films a-Si:H, the besieged plasma chemical deposition method (II XO), when TS=300 0C, power frequency discharge W=100W. However, the films studied in the present work, that when TS=200 ÷ 300 0C, micro structure parameter cannot vary in the range R= 0,1 ÷ 0,8. When annealing during 30 minutes in a vacuum at R value reaches 1.0. Accordingly, in this case, CH is 24.5 ÷ 14.0 at. %. By number of links Si-H, you can define a specific concentration of hydrogen containing links [Si-H]/[Si]. Specific concentrations of hydrogen containing Silicon links in the maximum reaches the value 0.58 [10–12].

Figure 3: Correlation of concentrations of hydrogen effusion method defined by the integrated force IW, at a frequency of 600 cm⁻¹-swing fashion 1, for films of a-Si₀.₆₀Ge₀.₄₀:H.

- the film received when hydrogen pressure 0.6 mTorr.
- the film received when hydrogen pressure 1.2 mTorr.
- the film received when hydrogen pressure 1.8 mTorr.
- the film received at a pressure of hydrogen 2.4 mTorr.
- the film received when hydrogen pressure 3.0 mTorr.

Therefore, the ratio of \( J_{2000} \) to \( J_{2100} \) compared to CH (at. %) (fig. 3). Change CH (at. %) for films at various temperatures heat up, shown in the table 1. Found that after effusion, during heat treatment up to 650°c, hydrogen concentration is NH=1.3 at. %. In doing so, found that the strength of the oscillator depend Q on hydrogen concentration (NH), It decreases after effusion of hydrogen; with increased hydrogen content (PH2) in the atmosphere of the received films a-Si₁₋ₓGeₓ:H When partial pressures from 0.6 to 3.0 m Torr power oscillator increases [5, 12]. This is due to the hydrogen containing links Ge:H, Si: H at specified frequency.

Heating the sample in a closed volume is due to the fact that the material almost completely decomposed into its constituent elements, with crystallization temperature range 350 ÷ 650 0C, what causes hydrogen jeffuziju and leads to increased pressure. Pressure measured capacitive pressure gauge with a precision of 0.1 %. To determine the effusion other gases should undertake quantitative mass spectrometric analysis of the composition of the gas. Note that the hydrogen inside the film identifies several ways: at. %NH, PH2 and P. To define these settings, you must remove the IR absorption spectra of the corresponding frequency fluctuations associated with the absorption of hydrogen.

### Optical properties of thin films

The dependence of \( (\alpha hν)^{2} \) on hv to determine the width of the forbidden zone [14, 16] for each film.

In all the studied films of the optical absorption edge ratio describes the ratio of:

\[
\alpha hν = B(hν - E_0)^{2} \quad (7),
\]

where is, \( \alpha = 5-104 \) cm⁻¹, E0 - optical band gap width for each film, B - the coefficient of proportionality. The value of the B determined by extrapolation of dependencies \( (\alpha hν)^{2} \) from hv for each sample. Quadratic dependence (7) received in theory model [13,14], Describes the density of States slit mobility. The value of the B when x=0±1 at.% Ge, for films a-SiₓGe₁₋ₓ:H changes from 527 before 343 eV·cm⁻¹/2, accordingly, E0=1.86 eV and E0=1,14 eV. Means with increasing content of Germany, E0 decreases. Mobility of carriers and photoconductivity in film a-SiₓGe₁₋ₓ:H, also diminishes when Germany more 40 at.% [11, 12]. We use the known relative absorption coefficient \( \alpha \) - is determined from the following equation [14 - 17]:

\[
T = \frac{(1-R_{1})(1-R_{2})(1-R_{3})\exp(-\alpha d)}{[1-R_{1}R_{2}R_{3}(1-R_{4})^{2}]\exp(-2\alpha d)} \quad (8)
\]

here take, that

\[
R_{1} = \left( n - l \right)^{2} + k_{l}^{2} \left\lfloor \frac{n + l}{2} + k_{l}^{2} \right\rfloor
\]

\[
R_{2} = \left( n - n_{1} \right)^{2} + k_{l}^{2} \left\lfloor \frac{n + n_{1}}{2} + k_{l}^{2} \right\rfloor \quad (9)
\]

\[
R_{3} = \left( n_{1} - l \right)^{2} \left\lfloor \frac{n_{1} + l}{2} \right\rfloor
\]

For weakly absorbing light areas \( k_{l}^{2} \leq (n-1.5) \cdot k_{s} \) shows light attenuation in the substrate. Note that the film thickness d, defined
in this case, the relevant transmission or reflection from extreme interference fringes.

From equation (8), the coefficients of absorption ($a$) are defined as follows:

$$T = \frac{kx}{a(1-bx)^2} \quad (10)$$

$$aT(1-bx)^2 = kx, \quad k = (1-R_1)(1-R_2)(1-R_3), \quad a = 1-R_1R_3,$$

$$b = R_1R_2 + R_3R_4(1-R_2)^3, \quad m = aTb, \quad n = aT,$$

$$mx^2 + kx - n = 0.$$

Then,

$$\alpha = \frac{1}{d} \cdot \frac{2m}{k \pm \sqrt{k^2 + 4mn}} \quad (11)$$

Equation (11) is a working formula for determining optical absorption coefficients for films, in a weakly absorbing spectral region.

In a strongly absorbing spectral regions $R_1 = 0, R_2 = R = R$, $n(\lambda) = \text{const}$ and $n = n_i = 1.5$ for glass substrates, a $n = n_s = 3.42$ for silicon substrate. Then equation (8) can be rewritten as follows:

$$T = \frac{(1-R)^2 e^{-2nd}}{1-R^2 e^{-2nd}}, \quad (12)$$

$$x = e^{-a d}; \quad x^2 = e^{-2ad}; \quad T = \frac{(1-R)^2 x}{1-R^2 x^2};$$

then,

$$\rho = \frac{(1-R)^2}{T} \cdot \alpha = \frac{1}{d} \ln \left[ \frac{1}{2} \left( \sqrt{p^2 + 4R^2} + p \right) \right] \quad (13)$$

This formula can be used to determine the coefficient of optical absorption in a strongly absorbing spectral regions. Accordingly, the coefficients of refraction is defined using the following ratio:

$$nd = \frac{\lambda_m \lambda_{m+1}}{2(\lambda_{m+1} - \lambda_m)}$$

or by using the following formula:

$$\Delta n = \frac{c}{2\pi^2} \int \frac{\omega(\nu)}{\nu^2} d\nu \quad (14)$$

where is $\lambda_m$ and $\lambda_{m-1}$ - the wavelength corresponding to the near bounding extreme and spectra of transparency or reflection (corresponding frequency, c - the speed of light). Refractive index is defined or the following formula [15]:

$$n(\lambda) = \left[ \left( \frac{2n_1(T_{\text{max}} - T_{\text{min}})}{T_{\text{max}} - T_{\text{min}}} \right) + \left( \frac{n_1^2 + 1}{2} \right)^2 \right]^{\frac{1}{2}},$$

where is $T_{\text{max}}$ and $T_{\text{min}}$ - functions of the wavelength $\lambda$, $n_i$ - index of refraction of the substrate, which is defined by the expression:

$$n_i = \frac{1}{T_i} \cdot \frac{1}{\sqrt{T_i^2 - 1}},$$

where is $T_i$ - deletion of the substrate, which is almost always in the area of transparency. As for glass substrates $T_i = 0.91$, $n_i = 1.554$. Accordingly, the film thickness is calculated by the formula:

$$d = \frac{A\lambda_2}{2[n(\lambda_2) - n(\lambda_1)]},$$

where is $\lambda_1$ and $\lambda_2$ - wavelengths which correspond to the neighboring extreme points on the spectrum bandwidth, $A=1$ for two extremes of the same type ($\text{max– max, min– min}$) and $A=0.5$ for two adjacent extremums of the opposite type ($\text{max– min, min– max}$).

**Creation of solar cells**

Studies show that films a-Si$_x$Ge$_{1-x}$: H ($x \approx 0.20$) can be used as a qualitative material in semiconductor electronics [12]. For this purpose, we have developed a 3-item based on two elements of cascade type. Three-layer element is made of 2-layer element consisting of two elements on the basis a-Si:H p-i-n transition and p-i-n element with i-layer film of a-Si$_{x,30}$Ge$_{1-x}$: H. The thickness i-layers to the top two transitions selected in such a way that respected condition of equality of short-circuit current lower element. Short circuit current was about half the value for an element with a p-i-n transition. Idling voltage and short current current decreases with increasing number of superimposed layers. This way you can build multiple layers (create n-layer element). Note that for each item produced 0.5 µm thick layer. The area of each element was 1.3 cm$^2$. When receiving a three-layer solar cells must be respected uniform thickness and square to each element. Substrate material of steel and was chosen as the cover used ZrO$_2$ with missing light 80%. Covering the same time playing the role of upper ZrO$_2$ (front) of the contact. The thickness of the layers of a-Si:H p- and n-types was ~ 300 and 400 Å, respectively. For alloying films number of B$_2$H$_6$ and PH$_3$ in gas mixtures changed within Alloy films in gas mixtures changed within 0.1 and 0.5%, respectively. After the deposition of amorphous semiconducting layers deposited by evaporation film ZrO$_2$ thickness ~ 500 Å. The upper contacts used Ni/Ag, for lower-stainless steel substrate. Items covered source sunlight provided AM$^1$ (100 mW/sm$^2$). Short-circuit current for 3-layer elements was 8.5 mA/cm$^2$, no-load voltage ~ 2.25 V, fill factor ~ 0.50 and CPA ~ 9.5% (рис.4). CPA for single-layer and double-layer element is 7% and 8.9%, respectively. The effectiveness of collecting media when different wavelengths is defined by the formula:

$$Y(\lambda) = \frac{J_0(\lambda)}{\epsilon N(\lambda)} \quad (15),$$

where is $J(\lambda)$ – the photocurrent density (10 mA/cm$^2$), $N(\lambda)$ – the number of photons incident per unit surface per second, e- free media charge.

For elements with the structures of the short-circuit current is calculated in the supposition of a complete depletion of all layers, in the absence of direct bias. Thus, the short circuit current for the first, second, and third elements provides the following expressions:

$$(1-R)N_{\text{reflect}} \exp(-3\alpha_0 W_1 - 2\alpha_0 W_2 - 2\alpha_1 W_1 - \alpha_1 W_2) \int [1 - \exp(-\alpha_0 W_1)] d\lambda \quad (16).$$
where is, \( W, W_i, W_p \) field distribution inside the \( i, n, p \) layer, respectively. \( N_{ph} \) - the number of photons incident on the surface of the elements, \( R \) - reflectivity film, \( \alpha \) - absorption coefficient for each layer elements.

Idling voltage for cascading elements with two and three transitions is presented as:

\[
V_\alpha(\lambda) = 0.5(E_{in} + E_{out})(17),
\]

\[
V_\alpha(\lambda) = 0.5(E_{in} + E_{out} + E_{out}) (18).
\]

The fill factor for all elements of the set size 0.5. Short-circuit current of a cascading element with two sets of values less transitions \( I_{sc}(\lambda) \) sets the lower value \( I_{sc1} \) and \( I_{sc2} \). Short-circuit current of a cascading element with three passages is determined by the smallest amount of \( I_{sc1}, I_{sc2} \) or \( I_{sc3} \).

CPA of many transitional cascade elements is given by the expression:

\[
\eta(i) = 0.5 \cdot 0.5 \left( \sum E_{in} \right) P_{sc} (19),
\]

where \( i \) = 2 and 3 - shows the number of layers, \( P_{sc} \) - power of incident light to the surface elements, its value is 100 mW/cm², \( E_{in}, E_{out}, E_{out} \) - Accordingly, the width of the forbidden zone for each \( i \) - the layer.

To raise \( \eta \) for solar cell, you want to increase the number of layers reduce the area elements, the choice of metal wires to reduce the resistance of the metal contacts, etc. Measurement of spectral sensitivity is usually produced at a constant illumination with white light, the intensity of which corresponds to the normal conditions of work (AM-1~100 mW/cm²), at the same time an element falls modulation calibrated monochromatic radiation. Photocurrent and its dependence on wavelength of monochromatic radiation is measured in shorted circuits by using synchronized amplifier. To determine the effectiveness of collecting important knowledge of the electric field which is passed to the element. It has been noticed that in device dependently to the configuration collection efficiency is offset from red light in the blue spectrum. It is known that the photon energy and momentum of the corresponding electromagnetic wave with frequency and wavelength in vacuum, equal:

\[
W = h\nu = \frac{hc}{\lambda} ; \quad P^* = \frac{h\nu}{c} = \frac{h}{\lambda} .
\]

where is, \( h \) - Planck's constant. When agile frequencies \( V \) - the preponderant role played by wave properties, at large \( V \) - particle properties of light. If \( P^* \) - electromagnetic radiation energy feeding okay on some surface unit area for 1 sec, \( c \) - the speed of propagation of light waves in a vacuum, \( R \) - reflectivity surface pressure \( p \) - light on this surface as well:

\[
P = (1 + R)N \frac{h\nu}{c} = P^*/c \cdot (1 + R) \quad (20),
\]

light pressure \( P \) is defined by equation (20) and represent the following form:

\[
p^* = \frac{W}{S} = \frac{hc \cdot N}{\lambda^2 \cdot t} \quad (21),
\]

\( N \) - the number of incident photons. \( W \) - photon energy falling at all wavelengths of the body surface. \( P^* \) -momentum light falling on dies surface for 1 sec. Then the pressure of the incoming light is defined in the following form:

\[
F = P^* \cdot S \quad \frac{hcN(1 + R)}{\lambda Stc} = \frac{hN(1 + R)}{\lambda t}
\]

\[
Ft = \frac{hN(1 + R)}{\lambda t} \quad \frac{Ft \cdot N}{h(1 + R)} = (22),
\]

\( F \) - the power of light pressure \( (F=10^4H) \) on the surface \((S=1\ cm^2)\), \( \lambda \) - incident wave length, \( t \) - time of incidence of the light for 1 sec. with energy \( P^* \) and its value is \( Nh\nu \) photons, with the momentum of each photon is equal to \( hv/c \). With radiation reflection \( R \), \( \lambda \) - the number falling photon is \( 10^{17}+10^{18} \ \text{m}^2\text{c}^{-1} \), \( \lambda = 300 + 900 \ \text{n}\text{m} \text{ (fig. 4)}.\)

![Figure 4: Characteristics of the solar cell when covering 100 mW/cm² for single-layer, double-layer and three-layer p-i-n structure.](image)

### Conclusion

Obtained thin films \( a-Si_{1-x}Ge_x:H \) (\( x=0+1 \)) plasma-chemical deposition method using gas mixtures of \( H_2 + SiH_4; H_2+GeH_4 \) in various proportions. It was determined that the highest \( R \) value (up to 0.8) is observed for films of \( a-Si: H \) deposited method (PH10) at temperature \( t = 300\ °C \) with an output frequency of discharge \( W = 100\ \text{W} \). The data on the ratio of \( g = \frac{G}{L} \). The oscillator strength in the film was evaluated \( a-Si_{1-x}Ge_x:H \), respectively \( I_S = I_S^{Ge} + I_S^{Si}, I_W = I_W^{Ge} + I_W^{Si} \). Oscillator strength \( Q=0.51 \) (for \( x=0 \)) and \( G=0.13 \) (for \( x=1 \)). For \( x=0.4 \) the maximum value \( P=4.16 \).

Based on the films \( a-Si:H \) and \( a-Si_{1-x}Ge_{0.12}:H \) manufactured solar cells and created single-layer, double-layer and three-layer structure; their characteristics are measured. Found that for single-layer, double-layer and three-layer structures with an area element 1.3 cm² \( \eta \) is 7%; 8.9%; 9.5% accordingly. For the three-
layered element highs move in the scope of collection efficiency of longer wavelengths. In the reporting structures of their light in the wavelength interval $0.3 \div 1.1 \mu m$ within 120 hours, there has been no degradation. It is shown that the multi-layer structure solar cells based on $\alpha$-$Si_{0.88}Ge_{0.12}:H$ and $\alpha$-$Si:H$ effective, and the improvement of their Efficiency are relevant tasks.

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Conflict of Interest

No Conflict of Interest.

References